

AOD66616

60V N-Channel AlphaSGT[™]

General Description

- Trench Power MOSFET AlphaSGTTM technology
- Low R_{DS(ON)}
- Excellent Gate Charge x R_{DS(ON)} Product (FOM)
- RoHS and Halogen-Free Compliant

Product Summary

 $\begin{array}{ll} V_{DS} & 60V \\ I_{D} \; (at \; V_{GS} \! = \! 10V) & 70A \\ R_{DS(ON)} \; (at \; V_{GS} \! = \! 10V) & < 3.7 m\Omega \\ R_{DS(ON)} \; (at \; V_{GS} \! = \! 6V) & < 5.4 m\Omega \end{array}$

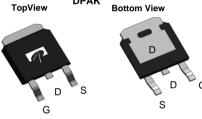
100% UIS Tested 100% Rg Tested

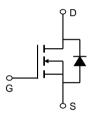


Applications

- Synchronous Rectification in DC/DC and AC/DC Converters
- Industrial and Motor Drive applications

TO252 DPAK





Orderable Part Number Package Type		Form	Minimum Order Quantity
AOD66616	TO-252	Tape & Reel	2500

Parameter		Symbol	Maximum	Units		
Drain-Source Voltage		V_{DS}	60	V		
Gate-Source Voltage		V_{GS}	±20	V		
Continuous Drain	T _C =25°C	1	70			
Current ^G	T _C =100°C	ID	70	A		
Pulsed Drain Current ^Ĉ		I _{DM}	280	7		
Continuous Drain	T _A =25°C	1	31	А		
Current	T _A =70°C	IDSM	25	^		
Avalanche Current ⁰		I _{AS}	35	Α		
Avalanche energy L=0.3mH ^C		E _{AS}	184	mJ		
	T _C =25°C	В	113	\\\		
Power Dissipation ^B	T _C =100°C	-P _D	45	W		
	T _A =25°C	В	6.2	\\\		
Power Dissipation A	T _A =70°C	P _{DSM}	4.0	W		
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C		

Thermal Characteristics						
Parameter		Symbol	Тур	Max	Units	
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\theta,JA}$	15	20	°C/W	
Maximum Junction-to-Ambient AD	Steady-State	ТЧДА	40	50	°C/W	
Maximum Junction-to-Case	Steady-State	$R_{\theta JC}$	0.9	1.1	°C/W	



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units	
STATIC PARAMETERS								
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$		60			V	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =60V, V _{GS} =0V				1	μA	
DSS	Zero Gate Voltage Drain Gurrent		T _J =55°C			5	μΑ	
I_{GSS}	Gate-Body leakage current	$V_{DS}=0V$, $V_{GS}=\pm20V$				±100	nA	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$		2.4	2.9	3.4	V	
		V _{GS} =10V, I _D =20A			2.9	3.7	mΩ	
$R_{DS(ON)}$	Static Drain-Source On-Resistance		Г _Ј =125°С		4.6	5.9	11177	
		V_{GS} =6V, I_D =20A			3.9	5.4	mΩ	
g _{FS}	Forward Transconductance	$V_{DS}=5V$, $I_{D}=20A$			100		S	
V_{SD}	Diode Forward Voltage	I _S =1A, V _{GS} =0V			0.7	1	V	
Is	Maximum Body-Diode Continuous Cur	ious Current ^G				70	Α	
DYNAMI	CPARAMETERS							
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =30V, f=1MHz			2870		pF	
Coss	Output Capacitance				940		pF	
C_{rss}	Reverse Transfer Capacitance				38		pF	
R_g	Gate resistance	f=1MHz		0.6	1.25	1.9	Ω	
SWITCH	ING PARAMETERS							
$Q_g(10V)$	Total Gate Charge	V _{GS} =10V, V _{DS} =30V, I _D =20A			42.5	60	nC	
Q_{gs}	Gate Source Charge				12		nC	
Q_{gd}	Gate Drain Charge				10		nC	
Q _{oss}	Output Charge	$V_{GS}=0V$, $V_{DS}=30V$			54		nC	
$t_{D(on)}$	Turn-On DelayTime				14.5		ns	
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =30V, R_L =1.5 Ω , R_{GEN} =3 Ω			15.5		ns	
$t_{D(off)}$	Turn-Off DelayTime				33		ns	
t _f	Turn-Off Fall Time				12.5		ns	
t _{rr}	Body Diode Reverse Recovery Time	I _F =20A, di/dt=500A/μs			26		ns	
Q_{rr}	Body Diode Reverse Recovery Charge	I_F =20A, di/dt=500A/ μ s			87		nC	

A. The value of R_{aJA} is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The Power dissipation P_{DSM} is based on R_{aJA} t≤ 10s and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design.

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B. The power dissipation P_D is based on $T_{J(MAX)}$ =150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Single pulse width limited by junction temperature $T_{J(MAX)}$ =150° C.

D. The $R_{\theta,JA}$ is the sum of the thermal impedance from junction to case $R_{\theta,JC}$ and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

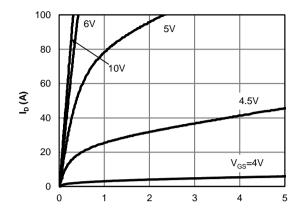
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.

G. The maximum current rating is package limited.

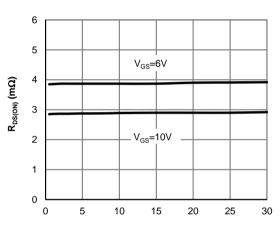
H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C.



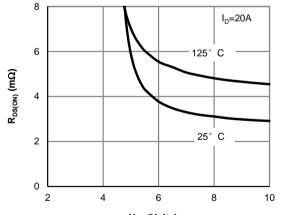
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



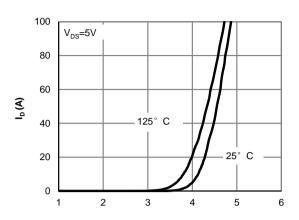
 $V_{\rm DS}$ (Volts) Figure 1: On-Region Characteristics (Note E)



 ${\rm I_D}$ (A) Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)



V_{GS} (Volts) Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)



V_{GS} (Volts) Figure 2: Transfer Characteristics (Note E)

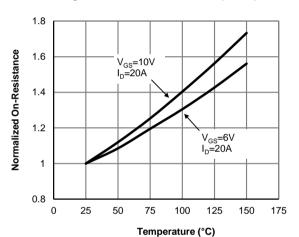
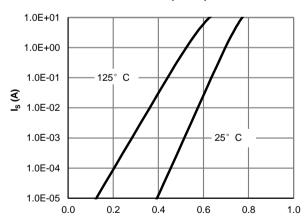


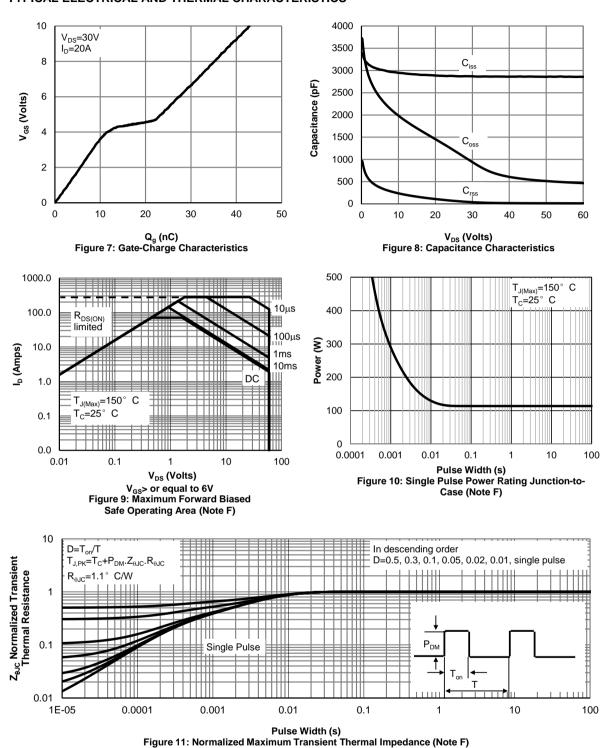
Figure 4: On-Resistance vs. Junction Temperature (Note E)



V_{SD} (Volts) Figure 6: Body-Diode Characteristics (Note E)

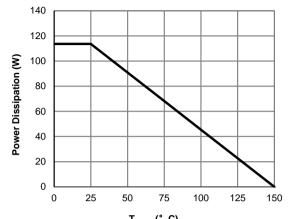


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

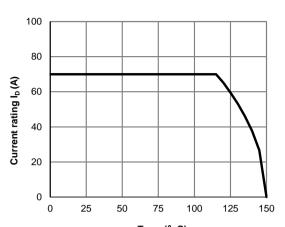




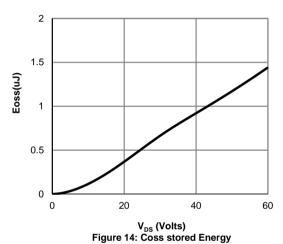
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

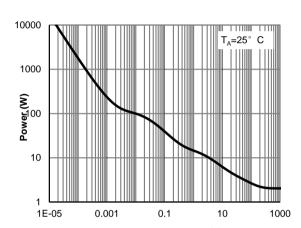


T_{CASE} (° C)
Figure 12: Power De-rating (Note F)

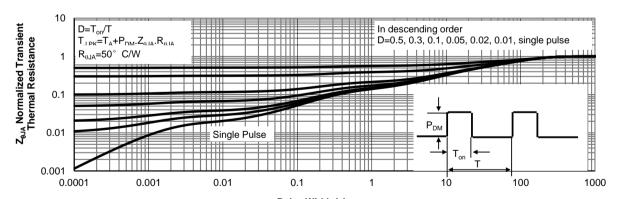


T_{CASE} (° C)
Figure 13: Current De-rating (Note F)





Pulse Width (s)
Figure 15: Single Pulse Power Rating Junctionto-Ambient (Note H)



Pulse Width (s)
Figure 16: Normalized Maximum Transient Thermal Impedance (Note H)

Figure A: Gate Charge Test Circuit & Waveforms

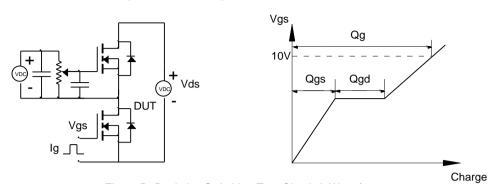


Figure B: Resistive Switching Test Circuit & Waveforms

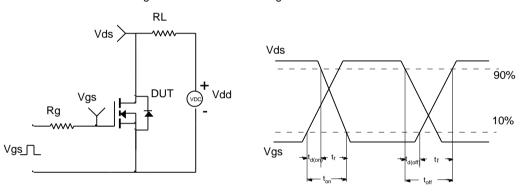


Figure C: Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

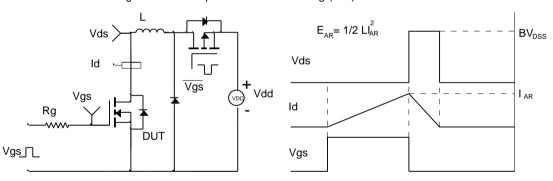


Figure D: Diode Recovery Test Circuit & Waveforms

